

5th Generation thinQ!™ SiC Schottky Diode

1 Description

ThinQ!TM Generation 5 represents Infineon leading edge technology for the SiC Schottky Barrier diodes. Thanks to the more compact design and thin-wafer technology, the new family of products shows improved efficiency over all load conditions, resulting from both the improved thermal characteristics and a lower figure of merit ($Qc \times Vf$).

The new thinQ!™ Generation 5 has been designed to complement our 650V CoolMOS™ families: this ensures meeting the most stringent application requirements in this voltage range.

Features

- Revolutionary semiconductor material Silicon Carbide
- · Benchmark switching behavior
- No reverse recovery/ No forward recovery
- Temperature independent switching behavior
- High surge current capability
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC¹⁾ for target applications
- Breakdown voltage tested at 44 mA²⁾
- Optimized for high temperature operation

Benefits

- System efficiency improvement over Si diodes
- System cost / size savings due to reduced cooling requirements
- Enabling higher frequency / increased power density solutions
- Higher system reliability due to lower operating temperatures
- Reduced EMI

Applications

- Switch mode power supply
- Power factor correction
- Solar inverter
- Uninterruptible power supply

Table 1 Key Performance Parameters

Parameter	Value	Unit
V_{DC}	650	V
$Q_{\rm C}; V_{\rm R} = 400 \rm V$	29	nC
E_{C} ; V_{R} =400V	6.6	μJ
<i>I_F</i> @ <i>T</i> _C < 120°C	20	Α

Table 2 Pin Definition

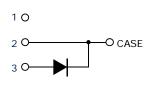
Pin 1	Pin 2	Pin 3
n.c.	С	Α

Type / ordering Code	Package	Marking	Related links
IDW20G65C5	PG-TO247-3	D2065C5	www.infineon.com/sic

- 1) J-STD20 and JESD22
- 2) All devices tested under avalanche conditions for a time periode of 10ms

IDW20G65C5









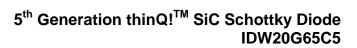




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Maximum ratings

2 Maximum ratings

Table 3 Maximum ratings

Parameter	Symbol	mbol Values			Unit	Note/Test Condition
		Min.	Тур.	Max.	1	
Continuous forward current	I _F	_	_	20		<i>T</i> _C < 120°C, D=1
Surge non-repetitive forward current	I _{F,SM}	_	_	103	1,	$T_C = 25^{\circ}\text{C}, t_p = 10 \text{ ms}$
sine halfwave		_	_	87	A	$T_{\rm C}$ = 150°C, $t_{\rm p}$ =10 ms
Non-repetitive peak forward current	$I_{F,max}$	_	_	776		$T_{\rm C}$ = 25°C, $t_{\rm p}$ =10 µs
i²t value	∫ i²dt	_	_	53	A²s	$T_C = 25^{\circ}\text{C}, t_p = 10 \text{ ms}$
		_	_	38		$T_{\rm C}$ = 150°C, $t_{\rm p}$ =10 ms
Repetitive peak reverse voltage	V_{RRM}	_	_	650	V	
Diode dv/dt ruggedness	dv/dt	_	_	100	V/ns	V _R =0480 V
Power dissipation	P _{tot}	_	_	112	W	$T_{\rm C}$ = 25°C
Operating and storage temperature	$T_j;T_{stg}$	-55	_	175	°C	
Mounting torque		_	_	60	Ncm	M3 and M3.5 screws

3 Thermal characteristics

Table 4 Thermal characteristics TO-247-3

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Тур.	Max.		
Thermal resistance, junction-case	R_{thJC}	_	1.0	1.3		
Thermal resistance, junction- ambient	R_{thJA}	_	_	62	K/W	leaded
Soldering temperature, wavesoldering only allowed at leads	T_{sold}	_	_	260	°C	1.6mm (0.063 in.) from case for 10 s

5th Generation thinQ![™] SiC Schottky Diode IDW20G65C5

Electrical characteristics

4 Electrical characteristics

Table 5 Static characteristics

Parameter	Symbol	Symbol Values			Unit	Note/Test Condition
		Min.	Тур.	Max.		
DC blocking voltage	$V_{ m DC}$	650	_	_		I_{R} = 0.21 mA, T_{j} = 25°C
Diode forward voltage	V_{F}	_	1.5	1.7	V	I _F = 20 A, T _j =25°C
		_	1.8	2.1		I _F = 20 A, T _j =150°C
Reverse current	I _R	_	1.1	210		V _R =650 V, T _j =25°C
		_	0.3	75	μΑ	V _R =600 V, T _j =25°C
		_	4.1	1450	1	V _R =650 V, T _i =150°C

Table 6 AC characteristics

Parameter	Symbol	Values		Unit	Note/Test Condition	
		Min.	Тур.	Max.		
Total capacitive charge	Qc	_	29		nC	V_R =400 V, <i>di/dt</i> =200A/µs, $I_F \le I_{F,MAX}$, T_f =150°C.
Total Capacitance	С	_	590	_		V _R =1 V, <i>f</i> =1 MHz
		_	76	_	pF	V _R =300 V, <i>f</i> =1 MHz
		_	74	_		V _R =600 V, <i>f</i> =1 MHz



Electrical characteristics diagrams

5 Electrical characteristics diagrams

Table 7

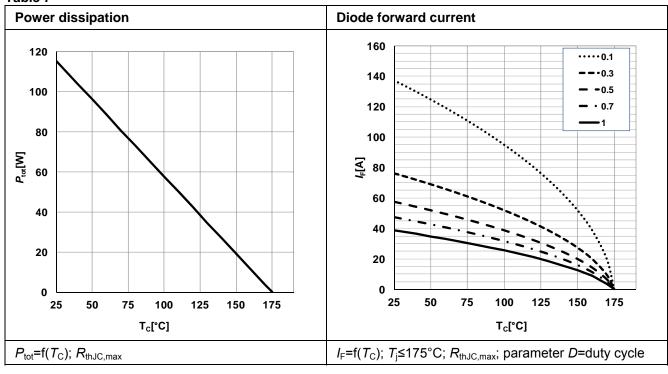
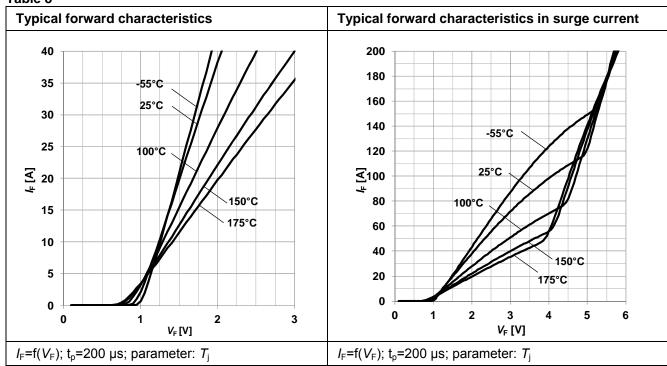


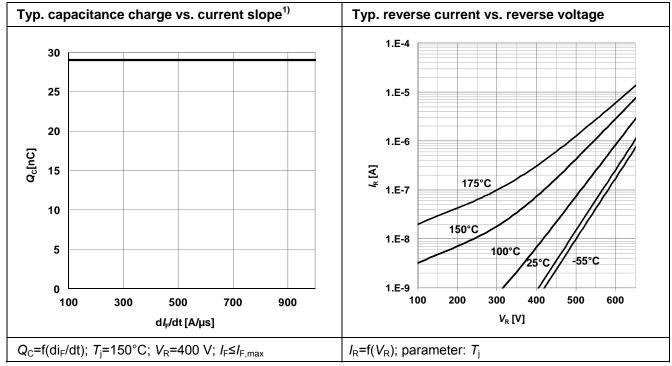
Table 8





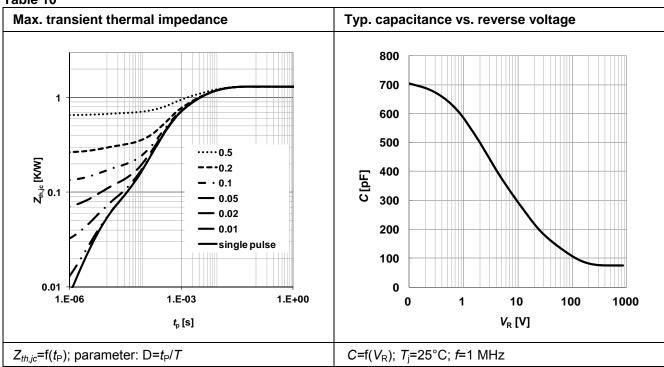
Electrical characteristics diagrams

Table 9



¹⁾ Only capacitive charge, guaranteed by design.

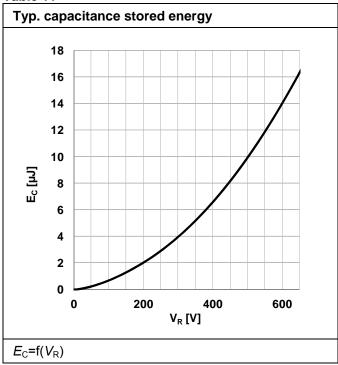
Table 10





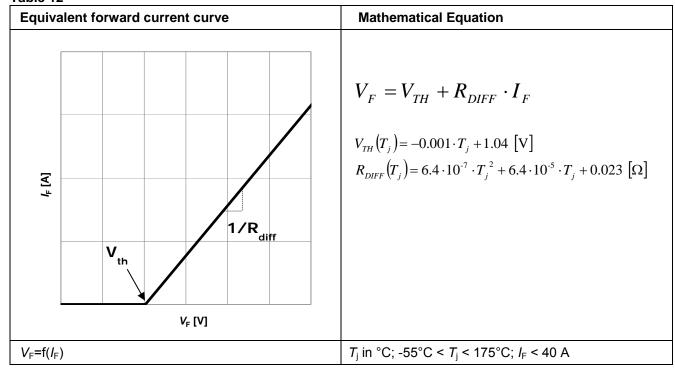
Electrical characteristics diagrams





6 Simplified Forward Characteristics Model

Table 12





Package outlines

7 Package outlines

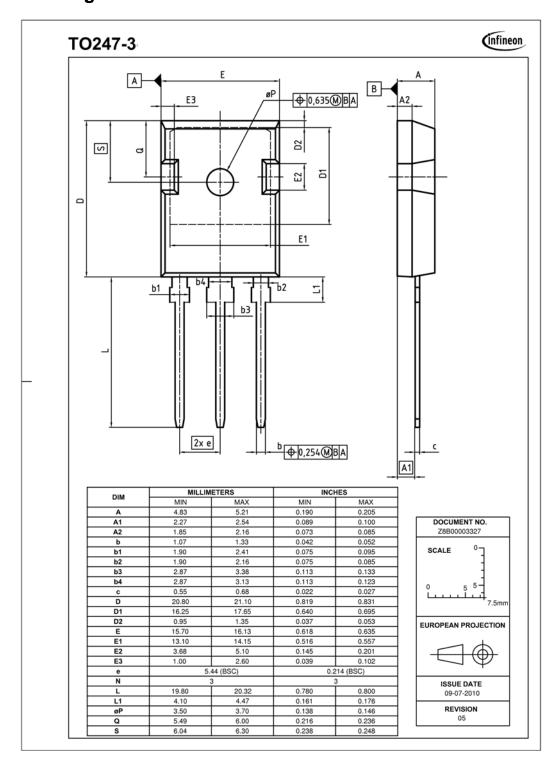


Figure 1 Outlines TO-247, dimensions in mm/inches

5th Generation thinQ!TM SiC Schottky Diode IDW20G65C5

Revision History

8 **Revision History**

5th Generation thinQ![™] SiC Schottky Diode

Revision History: 2013-01-15, Rev. 2.2

Previous Revision:					
Revision	Subjects (major changes since last version)				
2.0	Release of the final datasheet.				
2.1	Reverse current values, maximum diode forward voltage.				
2.2	Reverse current values, tested avalanche current, simplified calculation model				

We Listen to Your Comments

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